



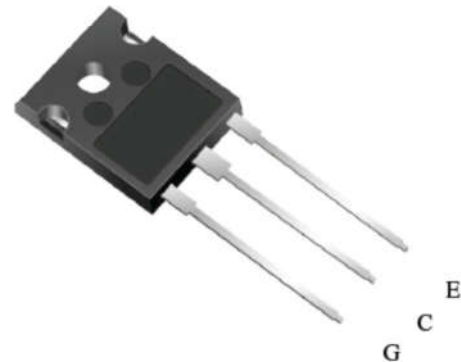
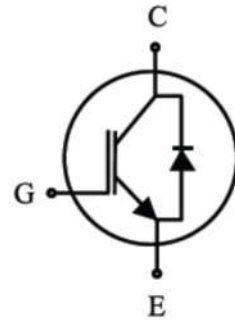
# SPT40N120T1B1

**1200V /40A Trench Field Stop IGBT**

## FEATURES

- High breakdown voltage to 1200V for improved reliability
- Trench-Stop Technology offering :
  - very tight parameter distribution
  - high ruggedness, temperature stable behavior
  - Short circuit withstand time – 10 $\mu$ s
  - High ruggedness, temperature stable
  - Low  $V_{CE(SAT)}$
  - Easy parallel switching capability due to positive temperature coefficient in  $V_{CE(SAT)}$
- Enhanced avalanche capability

$V_{CE}$	1200	V
$I_C$	40	A
$V_{CE(SAT)} I_C=40A$	1.7	V



## APPLICATION

- Frequency Converters
- Motor Drive



## Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-Emitter Breakdown Voltage	$V_{CE}$	1200	V
DC collector current, limited by $T_{jmax}$ $T_C = 25^\circ\text{C}$ $T_C = 100^\circ\text{C}$	$I_C$	80 40	A
Diode Forward current, limited by $T_{jmax}$ $T_C = 25^\circ\text{C}$ $T_C = 100^\circ\text{C}$	$I_F$	80 40	A
Pulsed Collector Current, limited by $T_{jmax}$	$I_{Cpuls}$	160	A
Turn off safe operating area $V_{CE} \leq 1200\text{V}$ , $T_j \leq 150^\circ\text{C}$	-	160	A
Diode Pulsed Current, limited by $T_{jmax}$	$I_{Fpuls}$	160	A
Short Circuit Withstand Time, $V_{GE} = 15\text{V}$ , $V_{CE} \leq 600\text{V}$	$T_{sc}$	10	$\mu\text{s}$
Power dissipation , $T_j = 25^\circ\text{C}$	$P_{tot}$	416	W
Operating junction temperature	$T_j$	-40...+150	$^\circ\text{C}$
Storage temperature	$T_s$	-55...+150	$^\circ\text{C}$
Soldering temperature, wave soldering 1.6mm (0.063in.) from case for 10s	-	260	$^\circ\text{C}$

## Thermal Resistance

Parameter	Symbol	Max. Value	Unit
IGBT thermal resistance, junction - case	$R_{\theta(j-c)}$	0.3	K/W
Diode thermal resistance, junction - case	$R_{\theta(j-c)}$	0.6	K/W
Thermal resistance, junction - ambient	$R_{\theta(j-a)}$	40	K/W

**Electrical Characteristics of the IGBT** ( $T_j = 25^\circ\text{C}$  unless otherwise specified) :

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>Static</b>						
Collector-Emitter breakdown voltage	$BV_{CES}$	$V_{GE}=0V, I_C=250\mu A$	1200	1300	-	V
Gate threshold voltage	$V_{GE(th)}$	$V_{GE}=V_{CE}, I_C=250\mu A$	5.1	5.8	6.4	V
Collector-Emitter Saturation voltage	$V_{CE(sat)}$	$V_{GE}=15V, I_C=40A$ $T_j = 25^\circ\text{C}$ $T_j = 150^\circ\text{C}$	- -	1.7 2.1	2.1 -	V
Zero gate voltage collector current	$I_{CES}$	$V_{CE} = 1200V, V_{GE} = 0V$ $T_j = 25^\circ\text{C}$ $T_j = 150^\circ\text{C}$	- -	- -	10 2500	$\mu A$
Gate-emitter leakage current	$I_{GES}$	$V_{CE} = 0V, V_{GE} = 20V$	-	-	100	nA
Transconductance	$g_{fs}$	$V_{CE}=20V, I_C=15A$	-	15	-	S

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>Dynamic</b>						
Input capacitance	$C_{ies}$	$V_{CE} = 25V, V_{GE} = 0V,$ $f = 1MHz$	-	4400	-	pF
Output capacitance	$C_{oes}$		-	180	-	
Reverse transfer capacitance	$C_{res}$		-	100	-	
Gate charge	$Q_G$	$V_{CC} = 960V, I_C = 40A,$ $V_{GE} = 15V$	-	270	-	nC
Short circuit collector current	$I_{C(SC)}$	$V_{GE}=15V, t_{sc}\leq 10\mu s$ $V_{CC}=600V,$ $T_{j, start}=25^\circ\text{C}$	-	240	-	A



### Switching Characteristic, Inductive Load

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>Dynamic , at <math>T_j = 25^\circ \text{C}</math></b>						
Turn-on delay time	$t_{d(on)}$	$V_{CC} = 600\text{V}, I_C = 40\text{A},$ $V_{GE} = 0/15\text{V},$ $R_g = 12\Omega$	-	55	-	ns
Rise time	$t_r$		-	20	-	ns
Turn-on energy	$E_{on}$		-	2.4	-	mJ
Turn-off delay time	$t_{d(off)}$		-	230	-	ns
Fall time	$t_f$		-	160	-	ns
Turn-off energy	$E_{off}$		-	1.5	-	mJ

### Electrical Characteristics of the DIODE ( $T_j = 25^\circ \text{C}$ unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>Dynamic</b>						
Diode Forward Voltage	$V_{FM}$	$I_F = 40\text{A}$	-	3.5	-	V
Reverse Recovery Time	$T_{rr}$	$I_F = 40\text{A},$ $V_R = 600\text{V},$ $di/dt = 400\text{A}/\mu\text{s},$	-	190	-	ns
Reverse Recovery Current	$I_{rr}$		-	6	-	A
Reverse Recovery Charge	$Q_{rr}$		-	530	-	nC



Fig. 1 FBSOA characteristics

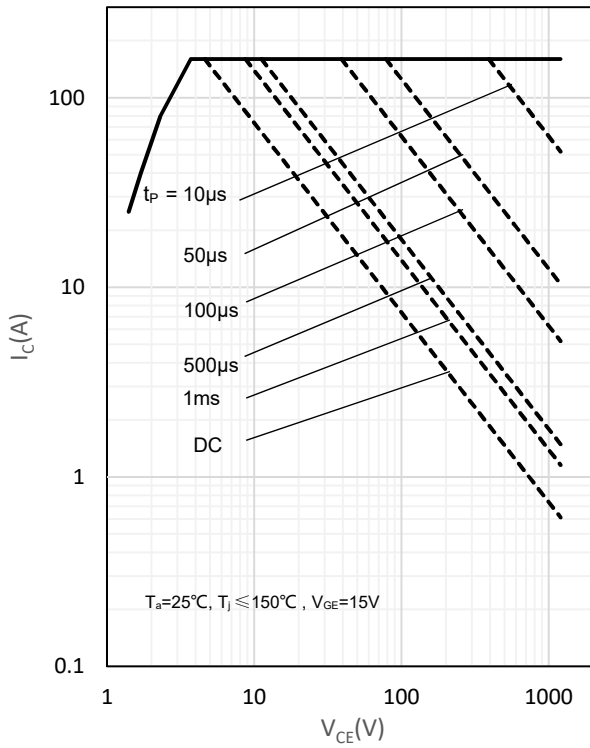


Fig. 2 Load Current vs. Frequency

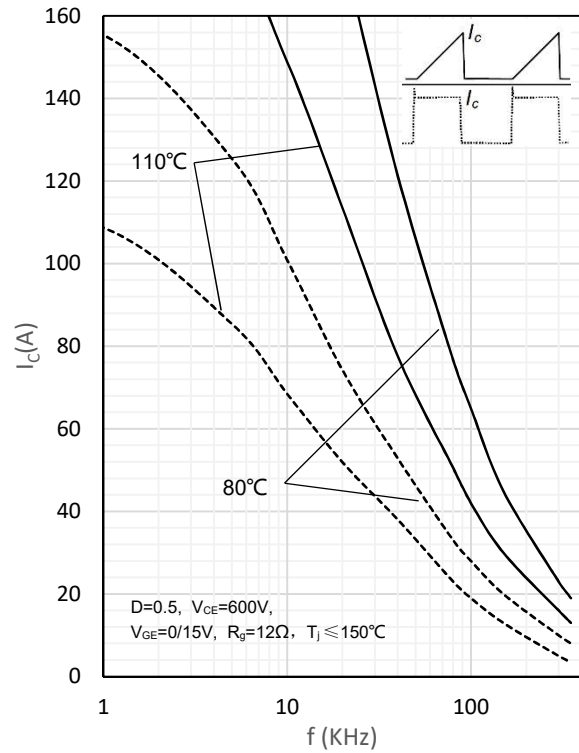


Fig. 3 Power dissipation as a function of  $T_C$

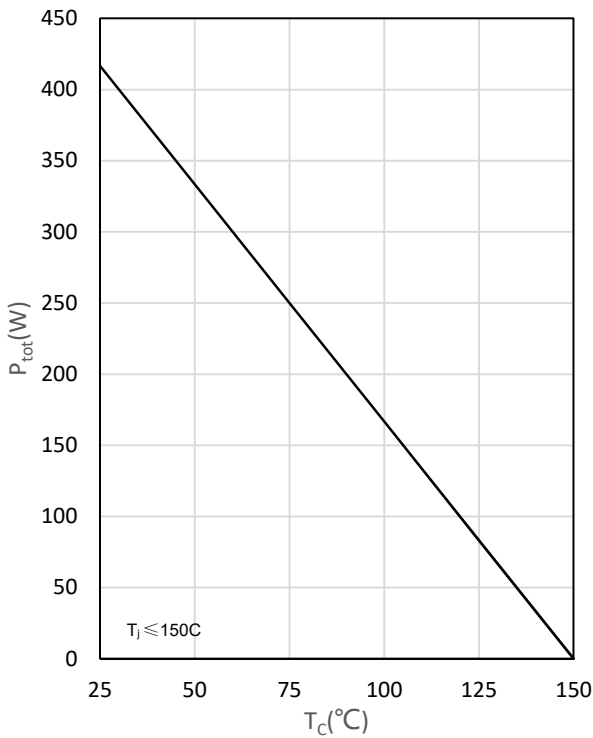


Fig. 4 Short circuit time and current vs.  $V_{GE}$

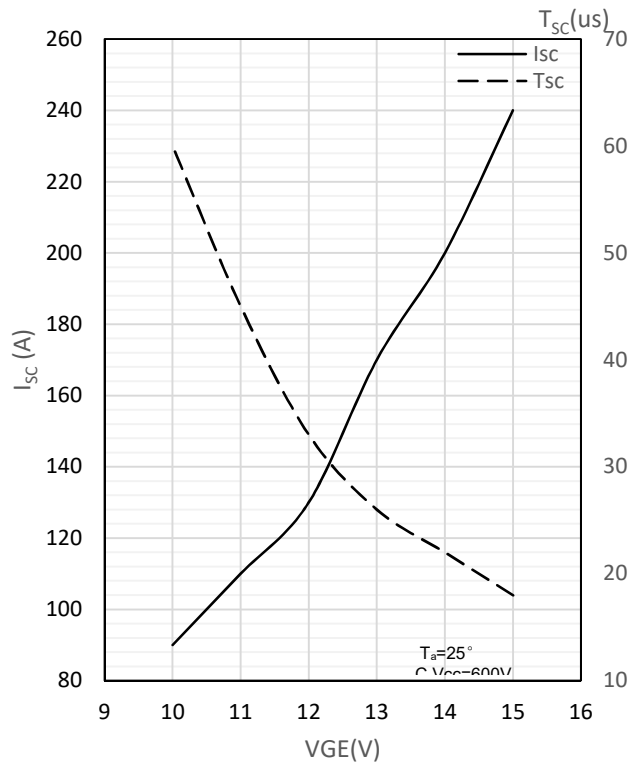




Fig. 5 Output characteristics

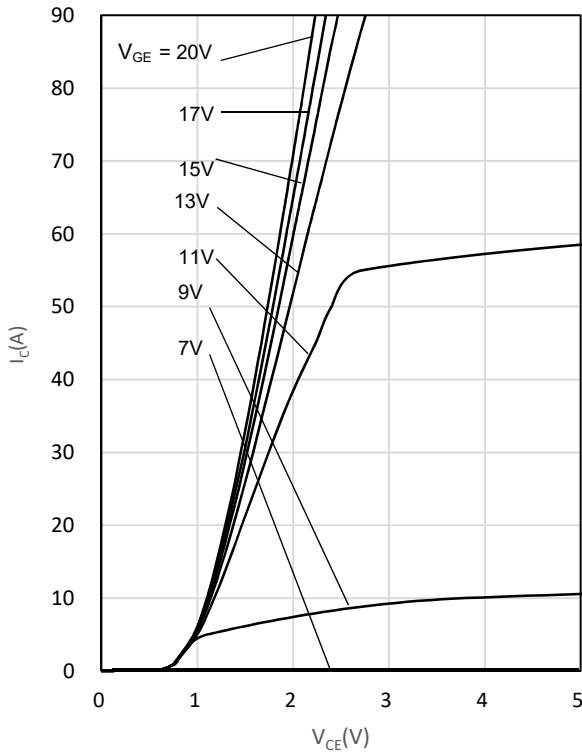


Fig. 6 Saturation voltage characteristics

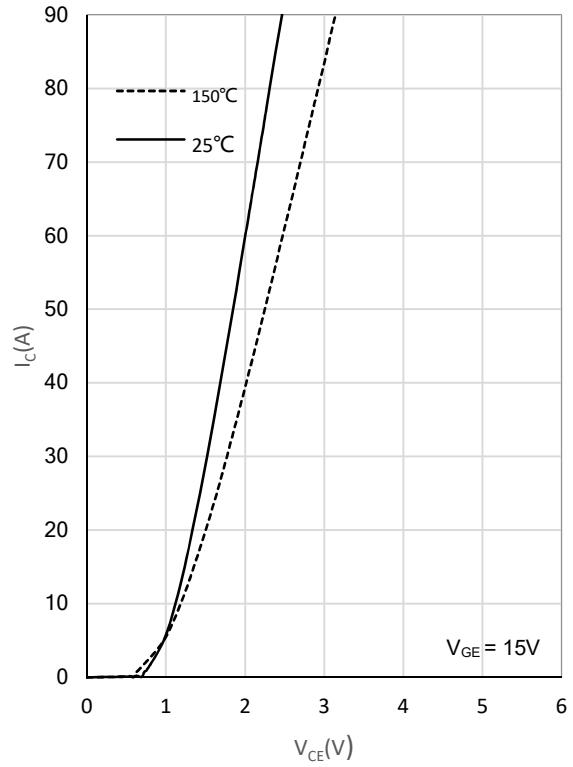


Fig. 7 Switching times vs. gate resistor

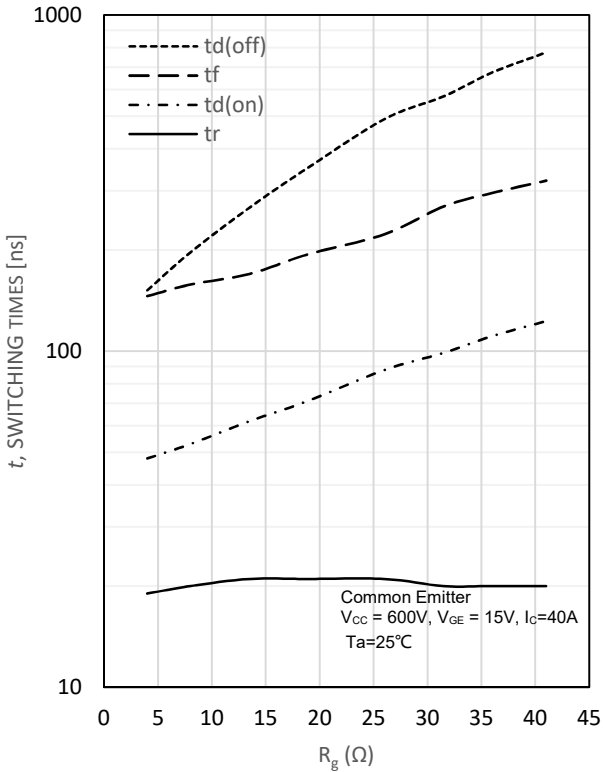


Fig. 8 Switching times vs. collector current

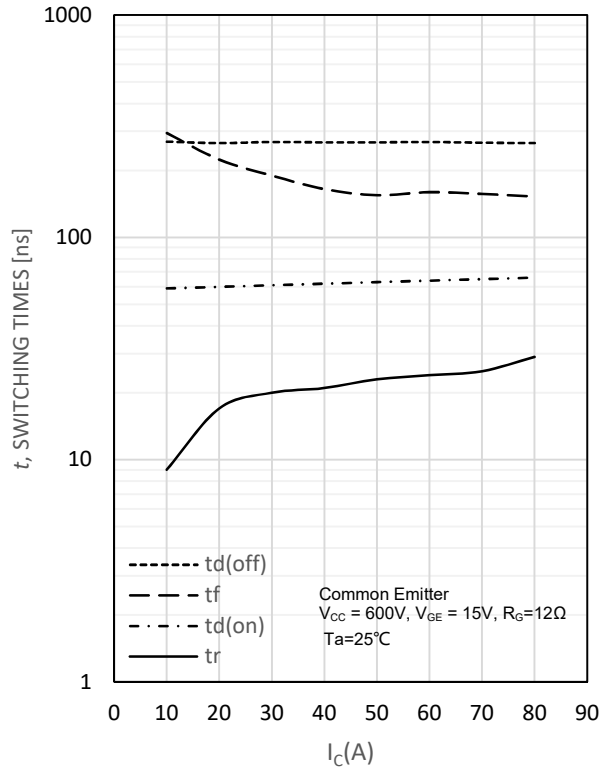




Fig. 9 Switching loss vs. gate resistor

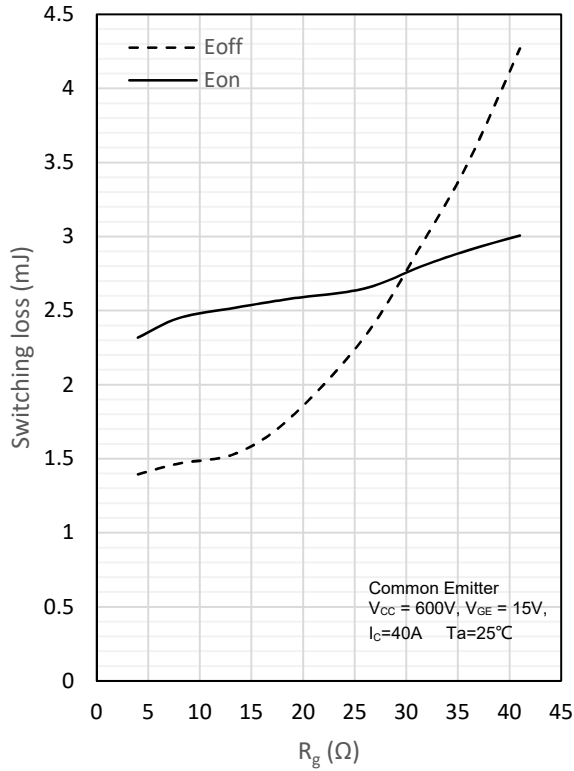


Fig. 10 Switching loss vs. collector current

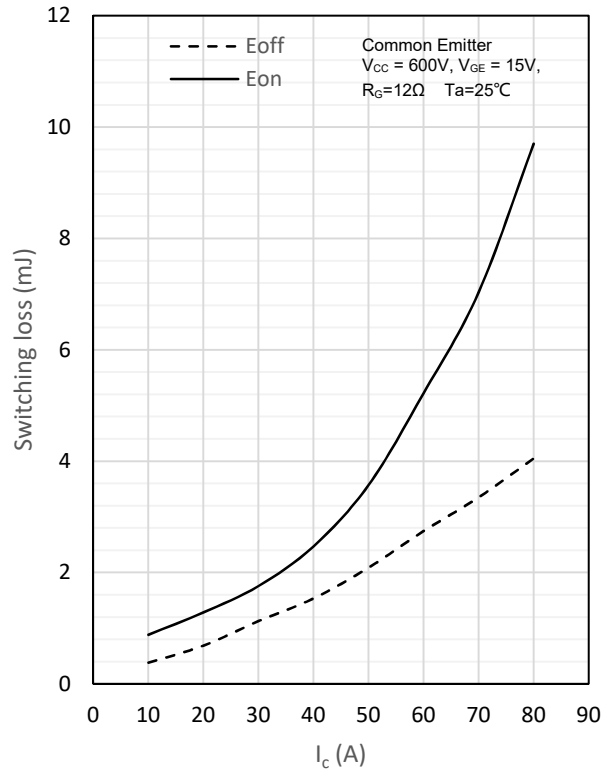


Fig. 11 Gate charge characteristics

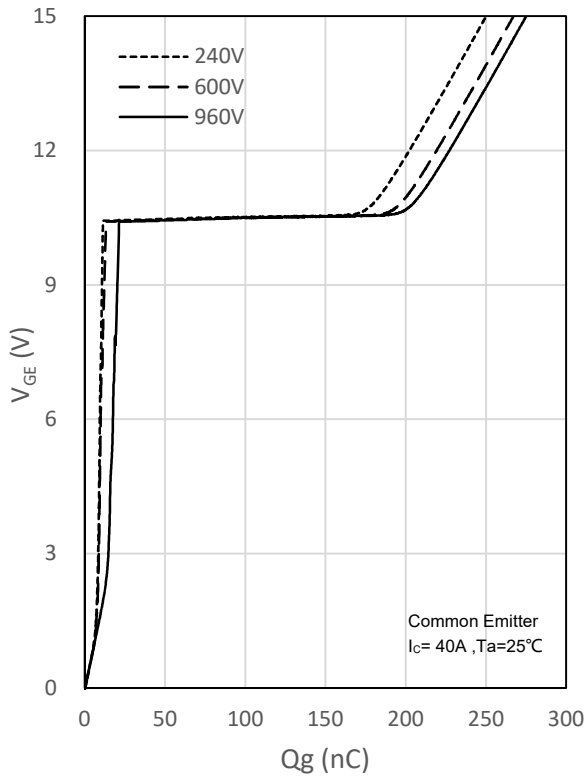
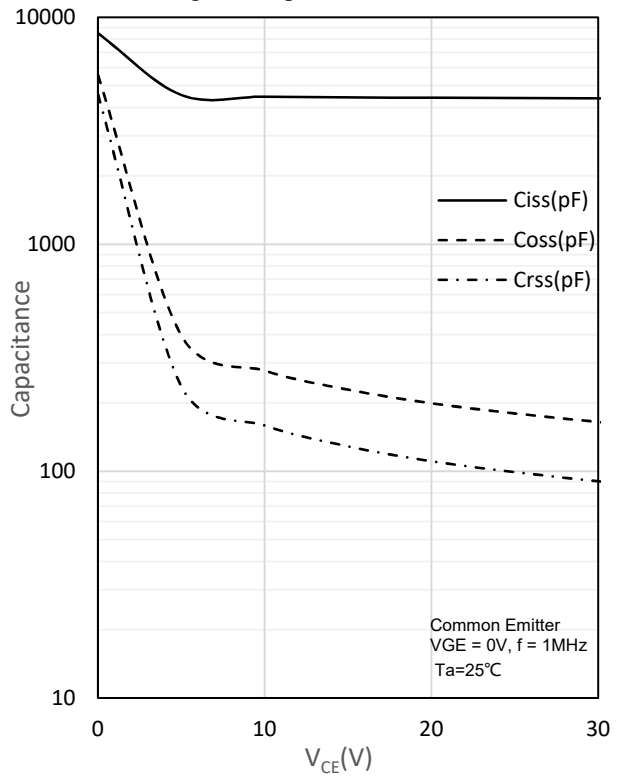
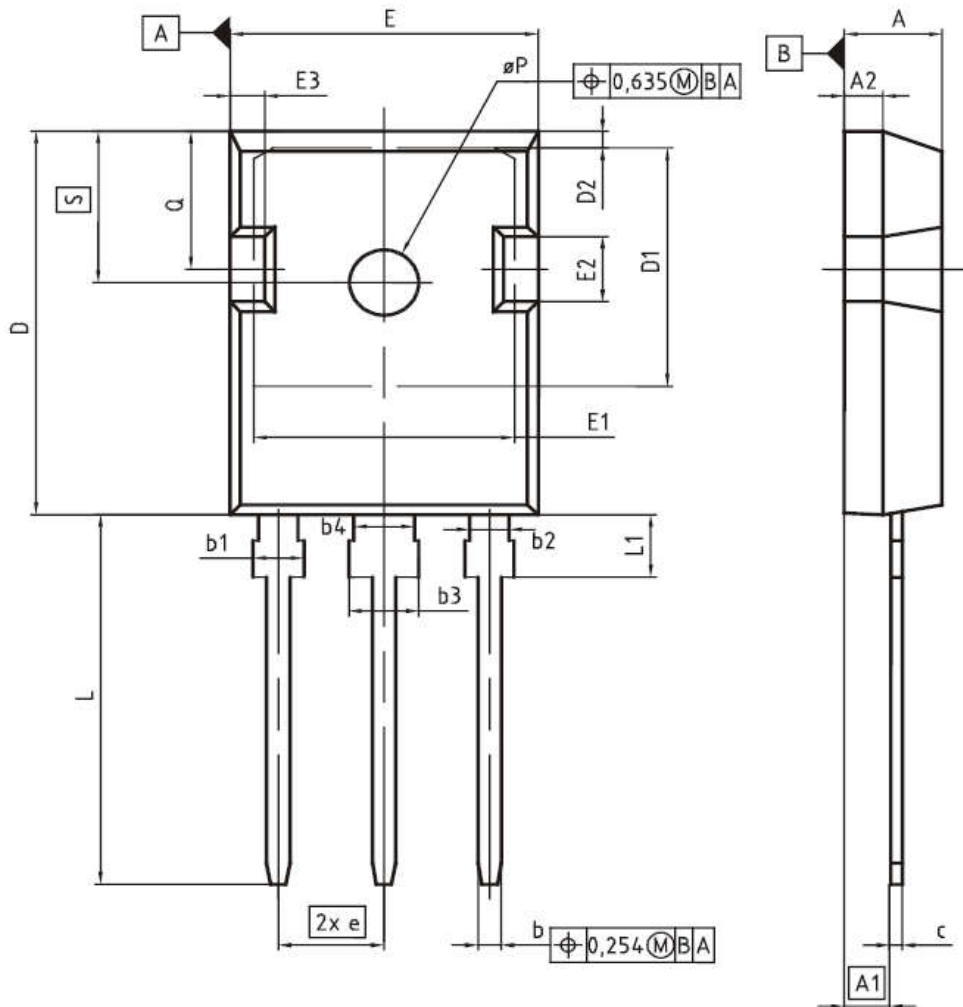


Fig. 12 Capacitance characteristics





**PG-TO247-3**



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.83	5.21	0.190	0.205
A1	2.27	2.54	0.089	0.100
A2	1.85	2.16	0.073	0.085
b	1.07	1.33	0.042	0.052
b1	1.90	2.41	0.075	0.095
b2	1.90	2.16	0.075	0.085
b3	2.87	3.38	0.113	0.133
b4	2.87	3.13	0.113	0.123
c	0.55	0.68	0.022	0.027
D	20.80	21.10	0.819	0.831
D1	16.25	17.65	0.640	0.695
D2	0.95	1.35	0.037	0.053
E	15.70	16.13	0.618	0.635
E1	13.10	14.15	0.516	0.557
E2	3.68	5.10	0.145	0.201
E3	1.00	2.60	0.039	0.102
e	5.44 (BSC)		0.214 (BSC)	
N	3		3	
L	19.80	20.32	0.780	0.800
L1	4.10	4.47	0.161	0.176
$\phi P$	3.50	3.70	0.138	0.146
Q	5.49	6.00	0.216	0.236
S	6.04	6.30	0.238	0.248